

Amendments to the Specification:

Please replace the title as follows:

~~DEVICE MANUFACTURING METHOD AND DEVICE, ELECTRO-OPTIC DEVICE,
AND ELECTRONIC EQUIPMENT~~

Please replace the paragraph beginning on page 46, line 15, with the following rewritten paragraph:

Then after respectively providing the electrode pads 15a (15b, 15c) in the concavities 38 in this way, paste form adhesive which is adjustable to liquid form is used as the conductive adhesive 36, and this is selectively discharged and arranged inside the ~~partitions 37~~ concavities 38 by the liquid droplet discharge method. In this case, it is desirable to more reliably perform selective application of the conductive adhesive 36, by performing lyophilic treatment inside the concavities 38 and liquid repellent treatment of the surroundings of the concavities 38 as illustrated in the eighth embodiment.